

General Purpose Transistor Medium Power, NPN

80 V, 1 A

Product Preview

BCP56M

The BCP56MTW is designed for general purpose amplifier applications. It is housed in DFN2020-3 offering superior thermal performance. The transistor is ideal for medium-power surface mount applications where board space and reliability are at a premium.

Specification Features

- Wettable Flank Package for Optimal Automated Optical Inspection (AOI)
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS (T_A = 25°C)

* **			
Rating	Symbol	Max	Unit
Collector-Emitter Voltage	V _{CEO}	80	Vdc
Collector-Base Voltage	V _{CBO}	100	Vdc
Emitter-Base Voltage	V _{EBO}	6.0	Vdc
Collector Current – Continuous (Note 1)	I _C	1.0	Α
Collector Current - Peak (Note 1)	I _{CM}	2.0	Α

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

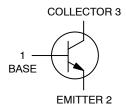
THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Power Dissipation (Note 2) @ T _A = 25°C Derate above 25°C	P _D	1.5	W
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ heta JA}$	78	°C/W
Total Power Dissipation (Note 3) @ T _A = 25°C Derate above 25°C	P _D	875	mW
Thermal Resistance, Junction-to-Ambient (Note 3)	$R_{ heta JA}$	138	°C/W
Junction and Storage Temperature Range	T _J , T _{stg}	-65 to +150	°C

- Reference SOA Curve
- 2. Surface-mounted on FR4 board using a 600 mm² pad area and 2 oz. Cu
- 3. Surface-mounted on FR4 board using a 100 mm² pad area and 2 oz. Cu

This document contains information on a product under development. **onsemi** reserves the right to change or discontinue this product without notice.





MARKING DIAGRAM



6M = Specific Device Code M = Date Code

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 2 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristics	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS			•	•	•
Collector-Emitter Breakdown Voltage (I _C = 1 mA, I _B = 0 A)	V _{(BR)CEO}	80	-	-	V
Collector-Base Breakdown Voltage (I _C = 100 μA, I _E = 0 A)	V _{(BR)CBO}	100	-	-	V
Emitter-Base Breakdown Voltage (I _E = 10 μA, I _C = 0)	V _{(BR)EBO}	5	-	-	V
Collector-Base Cutoff Current (V _{CB} = 30 V, I _E = 0)	I _{CBO}	-	-	100	nA
Emitter-Base Cutoff Current (V _{EB} = 5 V, I _C = 0)	I _{EBO}	-	-	100	nA
ON CHARACTERISTICS (Note 4)					
$\begin{array}{ll} \text{DC Current Gain} \\ \text{(I}_{C} = 5 \text{ mA, V}_{CE} = 2.0 \text{ V}) \\ \text{(I}_{C} = 150 \text{ mA, V}_{CE} = 2.0 \text{ V}) \\ \text{BCP56M} \\ \text{BCP56M10} \\ \text{BCP56M16} \\ \text{(I}_{C} = 500 \text{ mA, V}_{CE} = 2.0 \text{ V}) \\ \text{All Part Types} \\ \end{array}$	h _{FE}	63 63 63 100 40	- - - - -	_ 250 160 250 _	
Collector-Emitter Saturation Voltage (I _C = 500 mA, I _B = 50 mA)	V _{CE(sat)}	-	-	0.50	V
Base-Emitter Saturation Voltage (I _C = 500 mA, I _B = 50 mA)	V _{BE(sat)}	-	-	2.0	V
Base-Emitter Turn-on Voltage (I _C = 500 mA, V _{CE} = 2.0 V)	V _{BE(on)}	-	-	1.0	V
SMALL SIGNAL CHARACTERISTICS					
Transition Frequency (I _C = 10 mA, V _{CE} = 5.0 V, f = 100 MHz)		-	140	-	MHz
Output Capacitance (V _{CB} = 10 V, f = 1.0 MHz)	C _{obo}	-	65	-	pF
Input Capacitance (V _{EB} = -0.5 Vdc, I _C = 0, f = 1.0 MHz)	C _{ibo}	-	130	-	pF
Input Impedance ($I_C = -1.0 \text{ mAdc}$, $V_{CE} = -10 \text{ Vdc}$, $f = 1.0 \text{ kHz}$)	h _{ie}	-	4	-	k
Voltage Feedback Ratio (I _C = -1.0 mAdc, V _{CE} = -10 Vdc, f = 1.0 kHz)	h _{re}	-	0.4	-	X 10 ⁻⁴
Small–Signal Current Gain ($I_C = -1.0 \text{ mAdc}$, $V_{CE} = -10 \text{ Vdc}$, $f = 1.0 \text{ kHz}$)	h _{fe}	-	135	-	-
Output Admittance (I _C = -1.0 mAdc, V _{CE} = -10 Vdc, f = 1.0 kHz)	H _{oe}	-	4	-	μmhos
Noise Figure (I _C = 0.2 mA, V_{CE} = 5.0 Vdc, R_S = 2.0 k Ω , f = 1.0 kHz, BW = 200 Hz)	NF	-	1	_	dB
SWITCHING CHARACTERISTICS					
Delay Time (V _{CC} = 30 Vdc, I _C = 150 mA, I _{B1} = 15 mA)	t _d	-	20	-	ns
Rise Time (V_{CC} = 30 Vdc, I_C = 150 mA, I_{B1} = 15 mA)	t _r	-	20	-	ns
Storage Time ($V_{CC} = 30 \text{ Vdc}$, $I_{C} = 150 \text{ mA}$, $I_{B1} = 15 \text{ mA}$, $I_{B2} = 15 \text{ mA}$)	t _s	-	900	-	ns
Fall Time ($V_{CC} = 30 \text{ Vdc}$, $I_{C} = 150 \text{ mA}$, $I_{B1} = 15 \text{ mA}$, $I_{B2} = 15 \text{ mA}$)	t _f	-	110	-	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Condition: Pulse Width = 300 μ s, Duty Cycle \leq 2%.

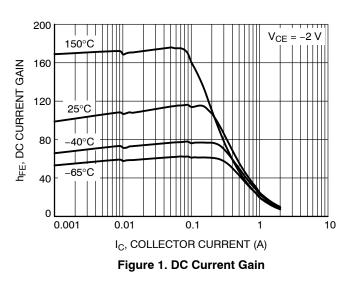
ORDERING INFORMATION

Device	Marking	Package	Shipping [†]		
BCP56MTWG	6M	WDFNW3 (Pb-Free)			
BCP5610MTWG	6N		3000 / Tape & Reel		
BCP5616MTWG	6P				
NSVBCP56MTWG*	6M		3000 / Tape & neer		
NSVBCP5610MTWG*	6N				
NSVBCP5616MTWG*	6P				

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{*}NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

TYPICAL CHARACTERISTICS



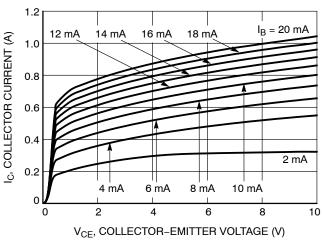


Figure 2. Collector Current vs. Collector Emitter Voltage

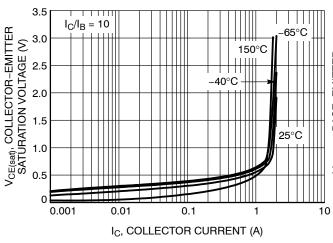


Figure 3. Collector Emitter Saturation Voltage vs. Collector Current

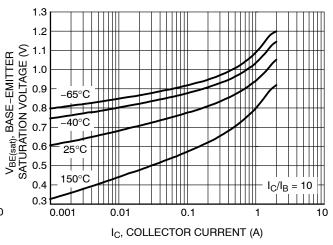


Figure 4. Base Emitter Saturation Voltage vs.
Collector Current

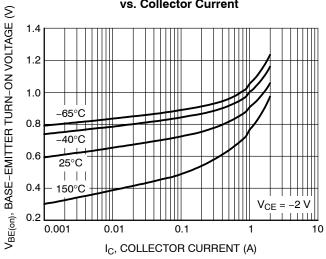


Figure 5. BCP53M, Base Emitter Turn-On Voltage vs. Collector Current V_{BE(on)}

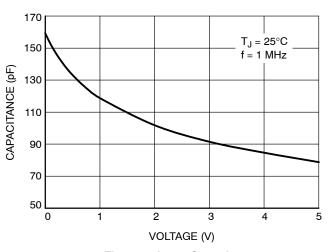


Figure 6. Input Capacitance

TYPICAL CHARACTERISTICS

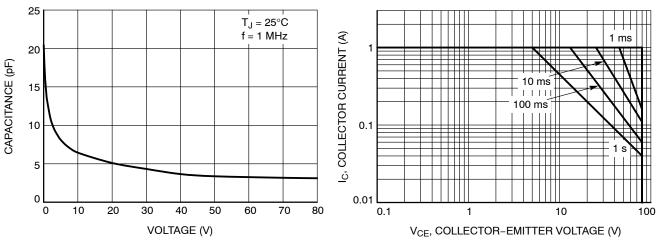


Figure 7. Output Capacitance

Figure 8. Safe Operating Area

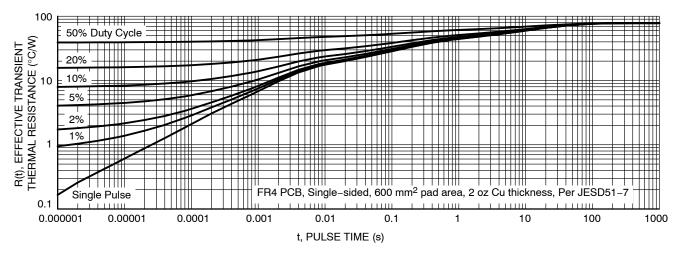


Figure 9. Transient Thermal Impedance from Junction-to-Ambient as a Function of Pulse Duration

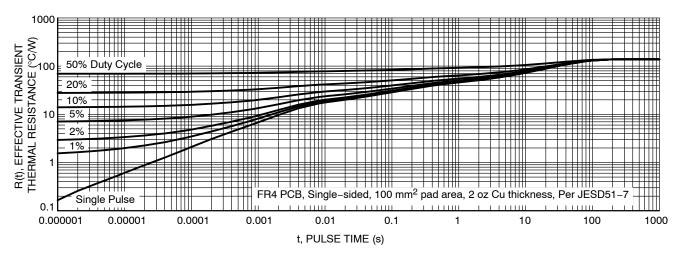


Figure 10. Transient Thermal Impedance from Junction-to-Ambient as a Function of Pulse Duration

PACKAGE DIMENSIONS

PIN A1 REFERENCE

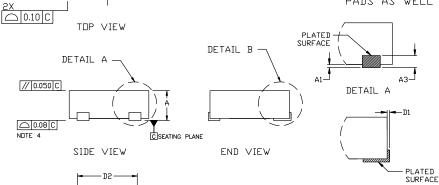
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WDFNW3 2x2, 1.3P CASE 515AA **ISSUE A**

DATE 26 JUL 2022

NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
- CONTROLLING DIMENSION: MILLIMETERS DIMENSION & APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30MM FORM THE TERMINAL
- COPLANARITY APPLIES TO THE EXPOSED PADS AS WELL AS THE TERMINALS.



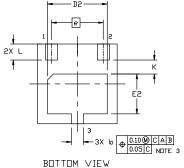
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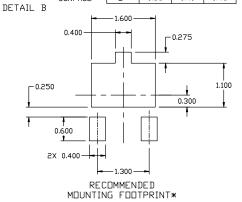
В

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D

	MILLIMETERS		
DIM	MIN.	N□M.	MAX.
Α	0.70	0.75	0.80
A1	0.00		0.05
A3	0.20 REF		
b	0.25	0.30	0.35
D	2.00 BSC		
D1	0.00		0.04
D2	1.40	1.50	1.60
Ε	2.00 BSC		
E2	0.90	1.00	1.10
e	1.30 BSC		
К	0.35 REF		
L	0.35	0.40	0.45





GENERIC MARKING DIAGRAM*



XX = Specific Device Code

= Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

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